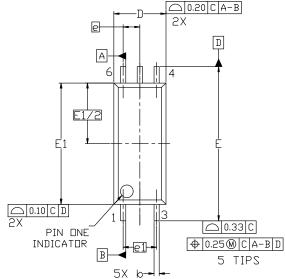




SOIC5 (6) 3.95x9.20x2.55, 1.27P CASE 752AF **ISSUE B**

DATE 24 JUL 2023

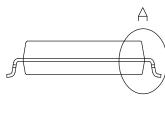
MILLIMETER



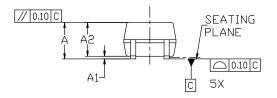


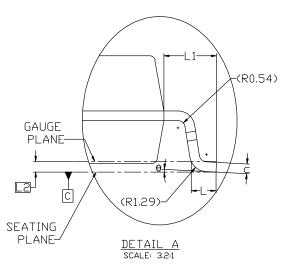


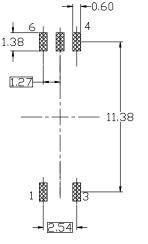
- THIS PACKAGE DOES NOT CONFORM TO ANY STANDARD.
- ALL DIMENSIONS ARE IN MILLIMETERS. B)
- DIMENSIONS ARE EXCLUSIVE OF BURRS, MOLD FLASH AND TIE BAR PROTRUSIONS.
- DRAWING CONFORMS TO ASME Y14.5M-1994.



ואוזת	MIN.	N□M.	MAX.
А			2.95
A1	0.10	0.20	0.30
A2	2.45	2.55	2.65
b	0.31	0.41	0.51
	0.19	0.22	0.25
D	3,85	3,95	4.05
E	11.60	11.70	11.80
E1	9,10	9.20	9,30
E1/2	4.60 BSC		
е	1.27 BSC		
e1	2.54 BSC		
Г	0.44	0.59	0.74
L1	1.15	1.25	1.35
L2	0.25 BSC		
0	0°		8°







LAND PATTERN RECOMMENDATION

*FOR ADDITIONAL INFORMATION ON OUR PB-FREE STRATEGY AND SOLDERING DETAILS, PLEASE DOWNLOAD THE ON SEMICONDUCTOR SOLDERING AND MOUNTING TECHNIQUES REFERENCE MANUAL, SOLDERRM/D.

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DESCRIPTION:	SOIC5 (6) 3.95x9.20x2.55, 1.27P		PAGE 1 OF 1	

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